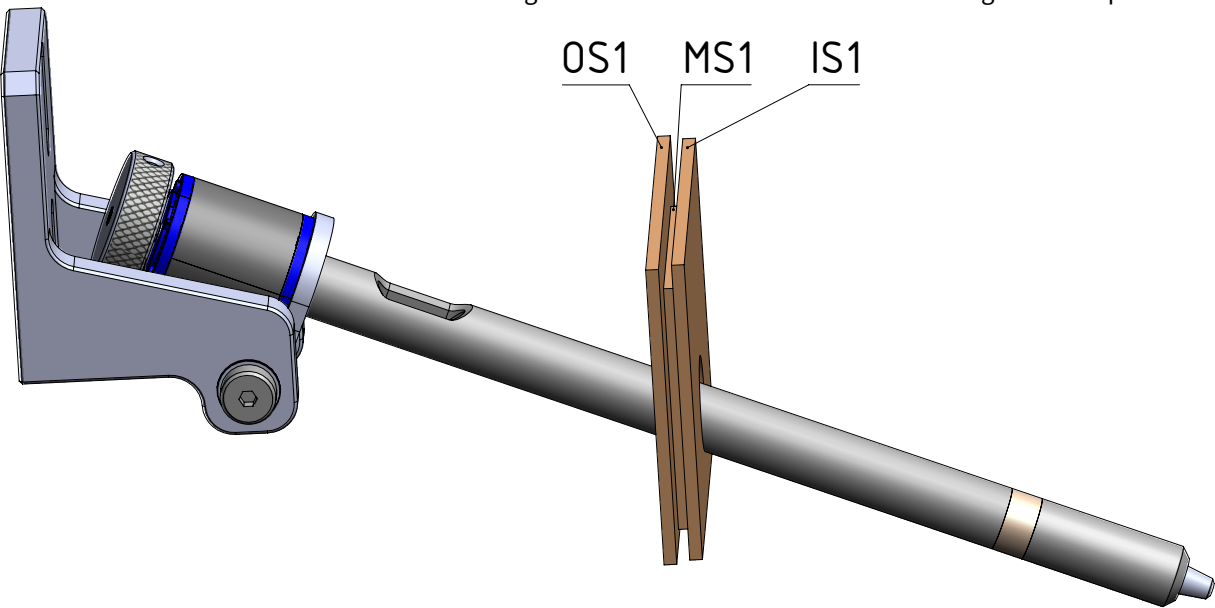


Sealing Kit PHD-4001-TH-Seal

Advanced TLP/HMM/HBM Solutions

1 Features

- Sealing Kit for PHD-PPM10-H9 on Cascade Octagon CM300 probe station



2 Description

Fig. 1 shows the physical dimensions and arrangement of the sealing kit. Fig. 2 shows the typical arrangement on the octagon CM300 wafer prober.

In case of no feed-through is required, the hole can be closed by rotating the MS1 by 180°.

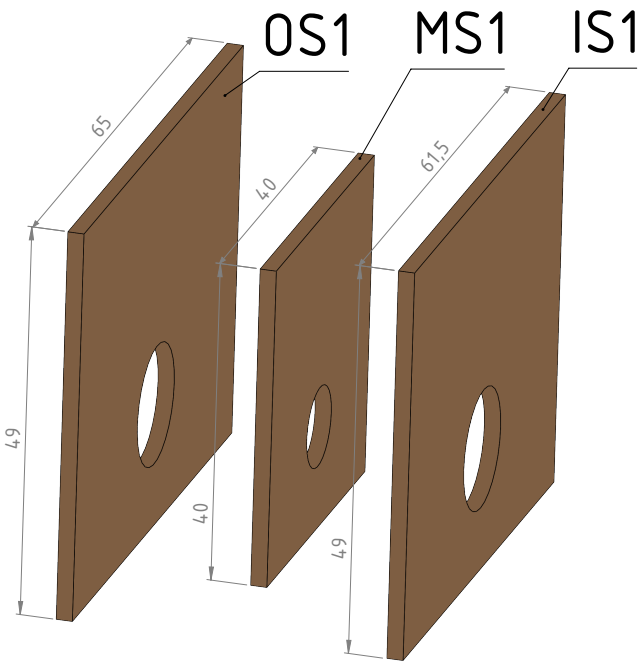


Figure 1: Physical dimensions PHD-4001-TH-Seal in [mm]

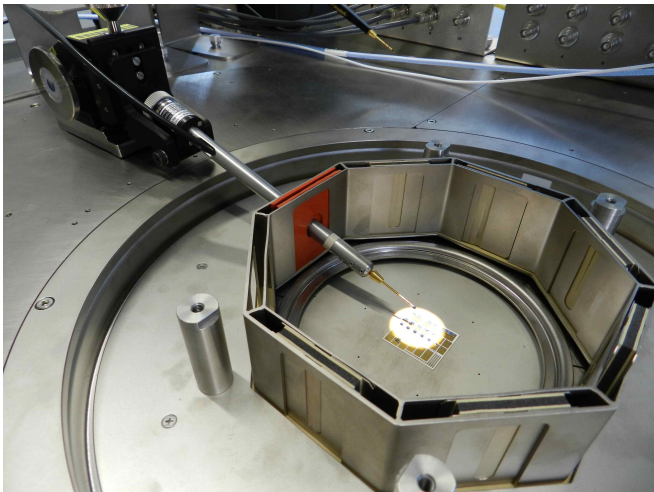


Figure 2: Typical application on CM300 probe station

3 Ordering Information

Pos.	Description	Part No.
01	Sealing Kit OS1/MS1/IS1	PHD-4001-TH-Seal

General

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